

L Number	Hits	Search Text	DB	Time stamp
1	1	("5164012").PN.	USPAT; US-PGPUB	2002/08/26 10:16
5	1	"4745088".PN.	USPAT;	2002/08/26 09:19
6	1	("5505385").PN.	USPAT; US-PGPUB	2002/08/26 10:17
14	1	(US-2652069-\$).did.	USOCR	2002/08/26 10:35
15	19		USPAT; US-PGPUB; JPO; DERWENT	2002/08/26 10:58
20	1	"58197724"	JPO	2002/08/26 11:10
21	6	((("3777987") or ("5029598") or ("5441570") or ("5500388") or ("5505385") or ("6352084"))).PN.	USPAT; US-PGPUB	2002/08/26 11:11
-	38983	c23c016\$.ipc.	JPO; DERWENT	2002/08/23 09:57
-	660865	h011021\$.ipc.	JPO; DERWENT	2002/05/07 13:21
-	0	((US-5458685-\$ or US-5571010-\$ or US-5888579-\$ or US-5294280-\$ or US-6147013-\$ or US-5480677-\$ or US-RE36328-\$ or US-5146869-\$ or US-6300600-\$ or US-5925188-\$ or US-6139642-\$ or US-6303906-\$ or US-6302963-\$ or US-6189482-\$ or US-6190460-\$ or US-6120285-\$ or US-6074486-\$).did.).PN.	USPAT; US-PGPUB	2002/08/23 09:39
-	17	(US-5458685-\$ or US-5571010-\$ or US-5888579-\$ or US-5294280-\$ or US-6147013-\$ or US-5480677-\$ or US-RE36328-\$ or US-5146869-\$ or US-6300600-\$ or US-5925188-\$ or US-6139642-\$ or US-6303906-\$ or US-6302963-\$ or US-6189482-\$ or US-6190460-\$ or US-6120285-\$ or US-6074486-\$).did.	USPAT; US-PGPUB	2002/08/23 09:50
-	2	"58197724"	JPO; DERWENT	2002/08/23 09:53
-	40812	c23c016\$.ipc.	JPO; DERWENT	2002/08/23 09:57
-	3	(137/\$.ccls. and 118/715.ccls.) and (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/08/23 10:48
-	2	5950675.URPN.	USPAT	2002/08/23 10:09
-	184	c23c016\$.ipc. and (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict))	JPO; DERWENT	2002/08/23 10:48
-	3080	pressure same (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict))	JPO; DERWENT	2002/08/23 10:49
-	970	pressure same (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict)) and (wafer substrate)	USPAT; US-PGPUB	2002/08/23 10:52
-	299	pressure same (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict)) same (wafer substrate)	USPAT; US-PGPUB	2002/08/23 13:28
-	2	((("5728260") or ("5618349"))).PN.	USPAT; US-PGPUB	2002/08/23 10:55
-	0	5728260.URPN.	USPAT	2002/08/23 11:06
-	6	5618349.URPN.	USPAT	2002/08/23 11:11
-	0	6402849.URPN.	USPAT	2002/08/23 11:12
-	1	6204194.URPN.	USPAT	2002/08/23 11:14
-	12	pressure same (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict)) same (wafer substrate) same vertical	USPAT; US-PGPUB	2002/08/23 11:19
-	234	pressure same (gas with (passage inlet tube) with (reduc\$3 narrow\$3 minimiz\$3 restrict)) and (wafer substrate)	JPO; DERWENT	2002/08/23 11:22
-	1	("5551165").PN.	USPAT; US-PGPUB	2002/08/23 13:28
-	494	(137/561r).CCLS.	USPAT; US-PGPUB	2002/08/23 14:08
-	318	(137/561a).CCLS.	USPAT; US-PGPUB	2002/08/23 14:08

-	12	2652069.URPN.	USPAT	2002/08/23 14:13
-	6	3650292.URPN.	USPAT	2002/08/23 14:15
-	8	4809744.URPN.	USPAT	2002/08/23 14:16
-	4	5095930.URPN.	USPAT	2002/08/23 14:18
-	2	5029598.URPN.	USPAT	2002/08/23 14:21
-	27	3777987.URPN.	USPAT	2002/08/23 14:24
-	8	4809744.URPN.	USPAT	2002/08/23 14:28
-	0	6220286.URPN.	USPAT	2002/08/23 15:04
-	31	4989540.URPN.	USPAT	2002/08/23 15:09
-	31	4989540.URPN.	USPAT	2002/08/23 15:14
-	1	"4430149".PN.	USPAT	2002/08/23 15:14
-	2	5789322.URPN.	USPAT	2002/08/23 15:34
-	0	20010025605.URPN.	USPAT	2002/08/23 16:21
-	0	7037832.URPN.	USPAT	2002/08/23 16:53
-	0	8199359.URPN.	USPAT	2002/08/23 16:55
-	6	5618349.URPN.	USPAT	2002/08/23 16:57
-	1	6204194.URPN.	USPAT	2002/08/23 16:59
-	10	5330352.URPN.	USPAT	2002/08/23 17:09
-	662	118/715.ccls. and (vertical)	USPAT; US-PGPUB	2002/08/23 17:23
-	189	118/715.ccls. and (vertical same (inner outer) )	USPAT; US-PGPUB	2002/08/23 18:42
-	14	4992301.URPN.	USPAT	2002/08/23 18:23
-	0	6248672.URPN.	USPAT	2002/08/23 18:24
-	9	5551984.URPN.	USPAT	2002/08/23 18:24
-	8	5164012.URPN.	USPAT	2002/08/23 18:31
-	21	vertical same ((inner outer) with tube) same (gas with (curv\$3 convex concave surroud\$3) )	USPAT; US-PGPUB	2002/08/23 18:49
-	7	vertical same ((inner outer) with tube) same (gas with (curv\$3 convex concave surroud\$3) )	EPO; JPO; DERWENT	2002/08/23 18:48
-	126	((inner outer) with tube) same (gas with (curv\$3 convex concave surroud\$3) )	EPO; JPO; DERWENT	2002/08/23 18:49
-	4	((inner outer) with tube) same (gas with (curv\$3 convex concave surroud\$3) ) and (wafer substrate semiconductor)	EPO; JPO; DERWENT	2002/08/23 18:50
-	57	((inner outer) with tube) same (gas with (curv\$3 convex concave surroud\$3) ) and (wafer substrate semiconductor)	USPAT;	2002/08/23 19:06
-	3305	(gas with (curv\$3 convex concave surroud\$3) ) and (wafer substrate semiconductor)	US-PGPUB	2002/08/23 19:15
-	2238	(gas with (curv\$3 convex concave surroud\$3) ) and (wafer substrate semiconductor) and (deposit\$3 etch\$3)	USPAT; US-PGPUB	2002/08/23 19:07
-	47	137/\$.ccls. and (gas with (curv\$3 convex concave surroud\$3) ) and (wafer substrate semiconductor)	USPAT; US-PGPUB	2002/08/23 19:16